

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.	:	10/549,440	Confirmation No. 5587
Applicant	:	Takeo Okabe	
371 Filed	:	September 16, 2005	
Art Unit	:	1793	
Examiner	:	Sikyin Ip	
Customer No.	:	00270	
Title	:	COPPER ALLOY SPUTTERING TARGET, PROCESS FOR PRODUCING THE SAME AND SEMICONDUCTOR ELEMENT WIRING	

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

This is an Amendment submitted in timely response to a non-final Office Action dated July 8, 2009. Kindly amend the application as set forth below.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.